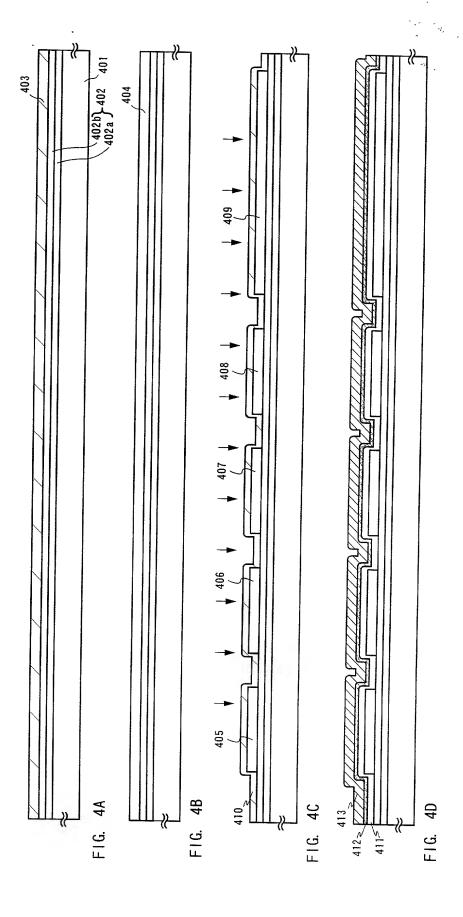
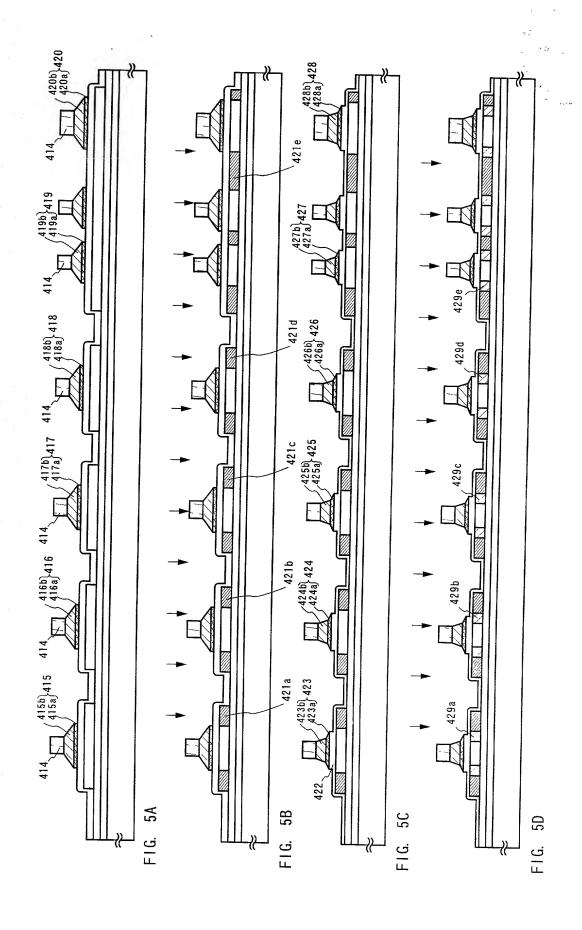
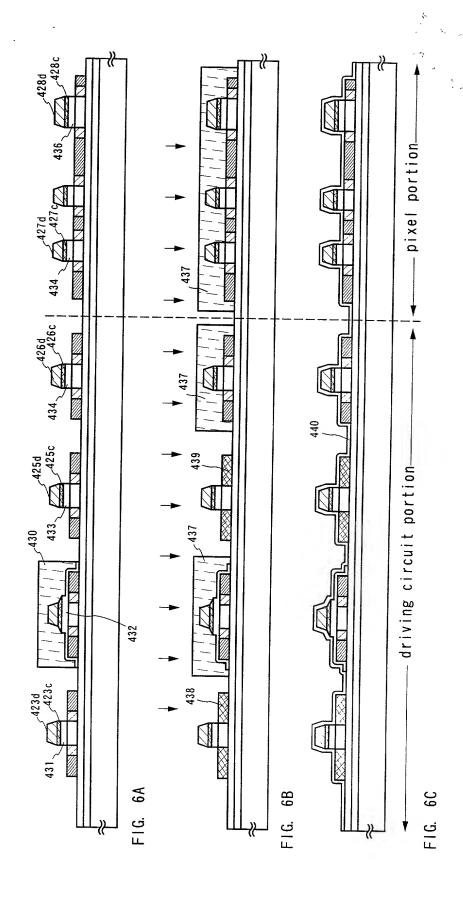
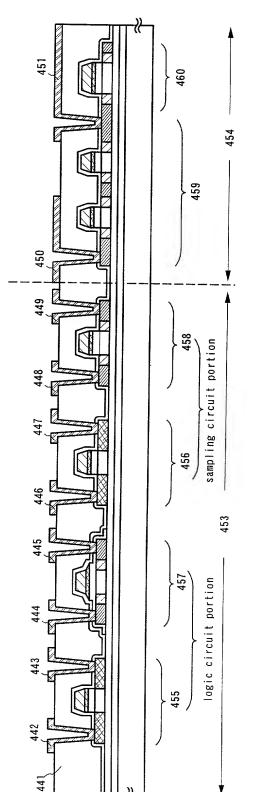


FIG. 3B









F1G. 7

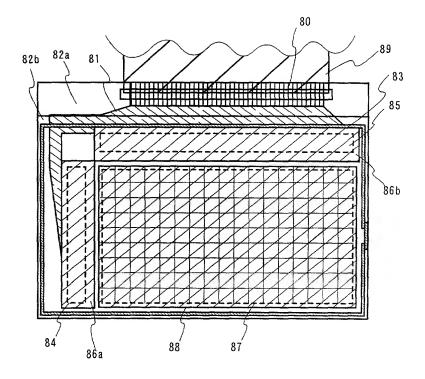


FIG. 8

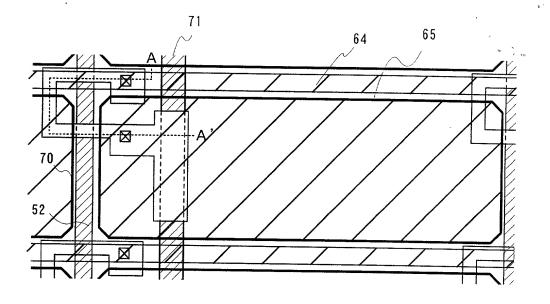


FIG. 9A

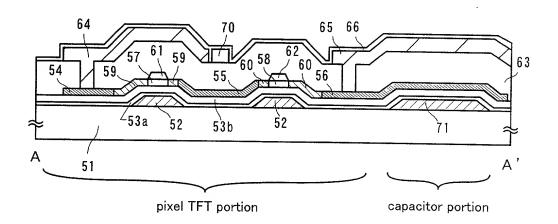
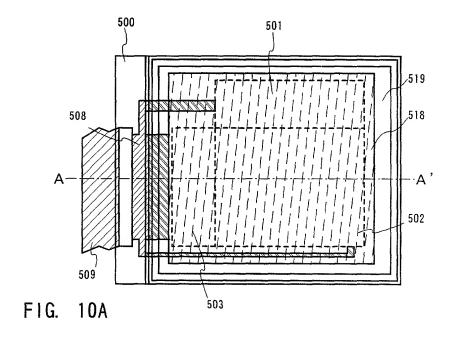
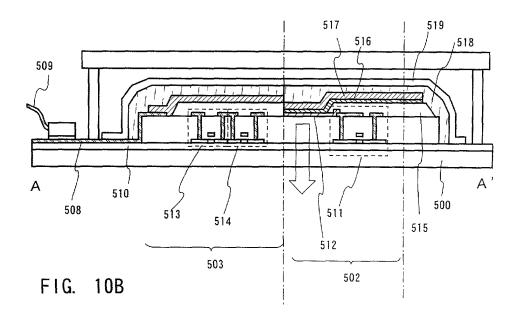


FIG. 9B





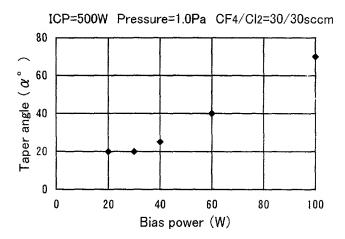


FIG. 11 Dependence of taper angle on bias power.

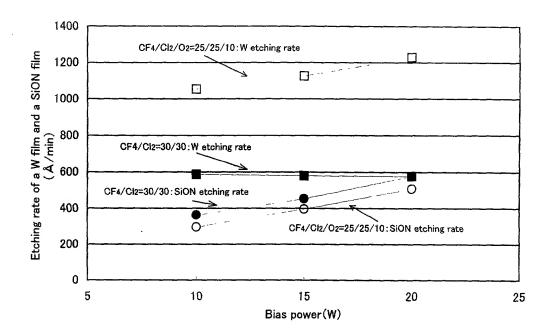


Fig. 12 Dependence of an etching rate of a W film and an SiON film on bias power.

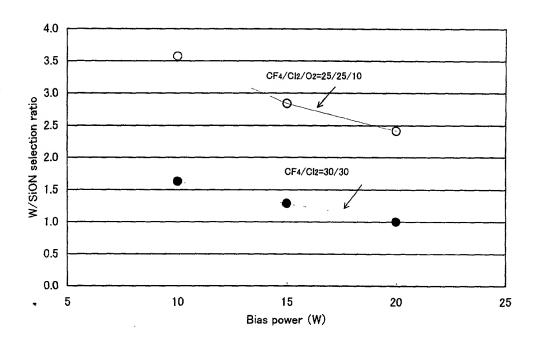


Fig. 13 Dependence of a selection ratio between a W film and an SiON film on a bias power.

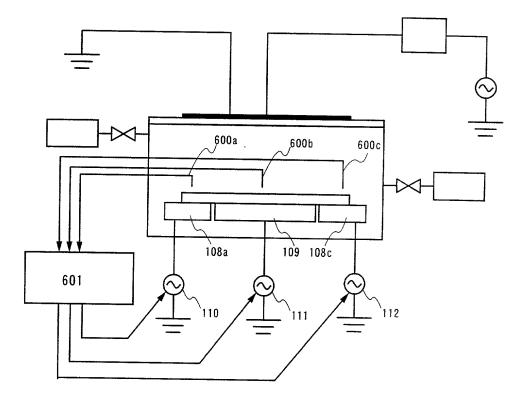
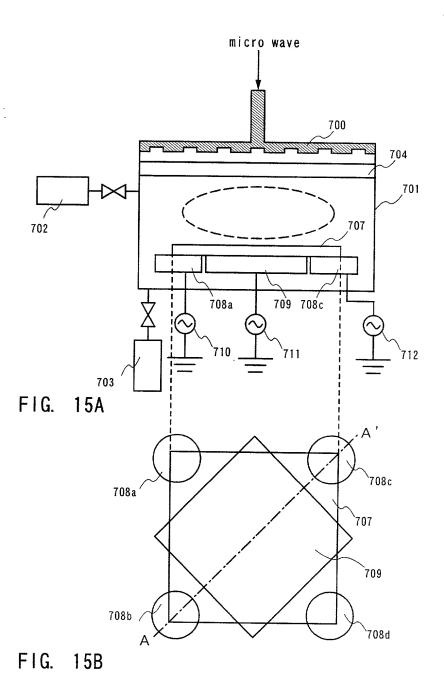
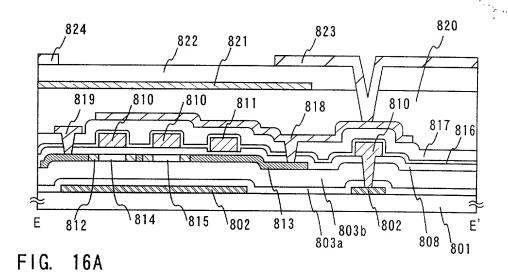


FIG. 14





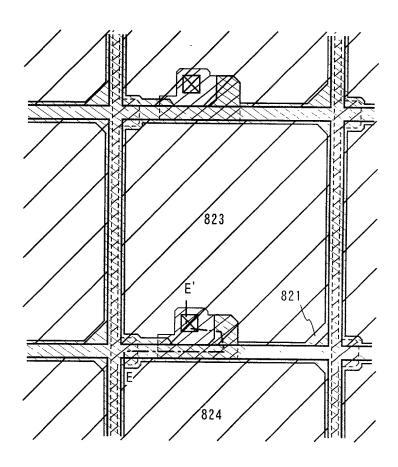


FIG. 16B

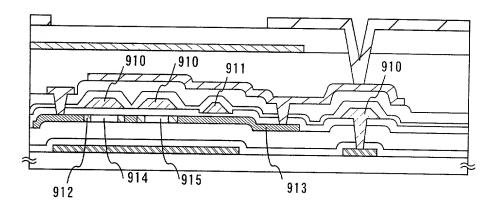


FIG. 17

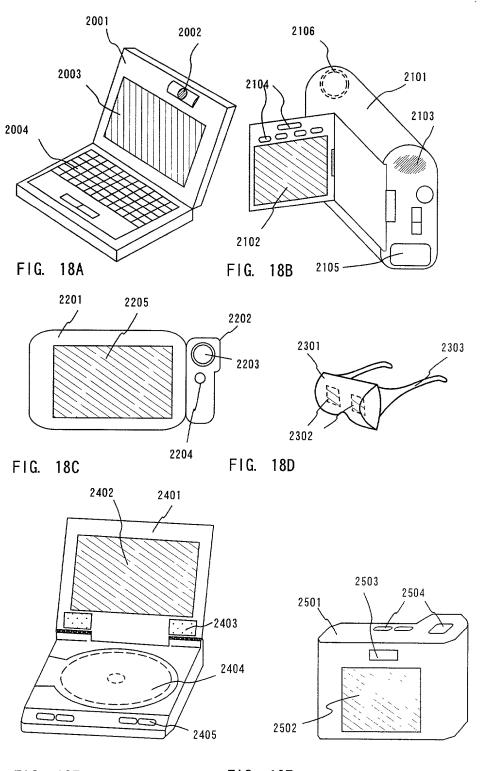


FIG. 18E

FIG. 18F

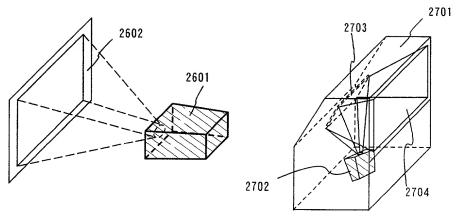


FIG. 19A

FIG. 19B

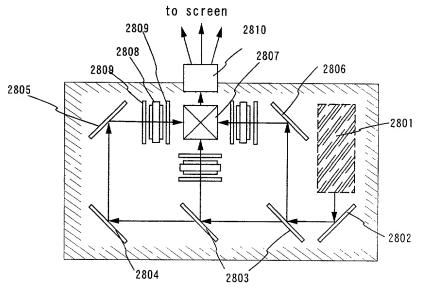


FIG. 19C

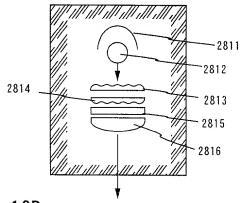


FIG. 19D

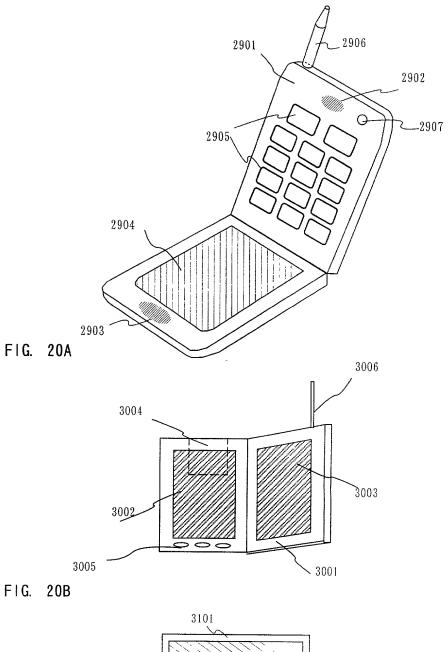


FIG. 20C 3103

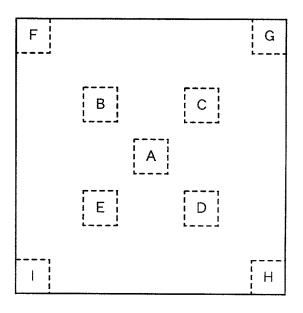


FIG. 21A

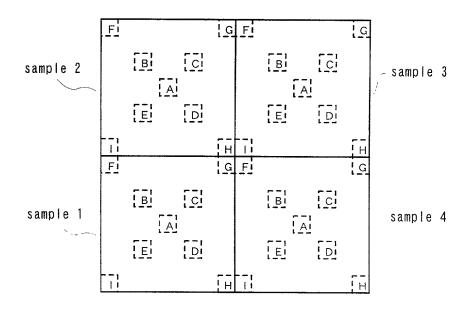


FIG. 21B